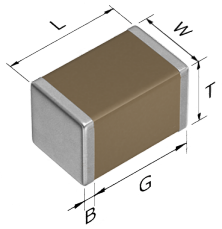
Multilayer Ceramic Chip Capacitors

CGA4J1X8L0J106K125AC

Product Status	Production
TDK Item Description	CGA4J1X8L0J106KT****
Applications	Automotive Grade
Feature	AEC-Q200AEC-Q200 150°CHigh Temperature Application
Series	CGA4(2012) [EIA 0805]
Brand	TDK
Environmental Compliance	RoHS, REACH, Halogen Free, Lead Free



Size	
Length(L)	2.00mm ±0.20mm
Width(W)	1.25mm ±0.20mm
Thickness(T)	1.25mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering) 0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	10µF ±10%
Rated Voltage	6.3VDC
Temperature Characteristic	X8L(+15,-40%)
Dissipation Factor (Max.)	7.5%
Insulation Resistance (Min.)	10MΩ

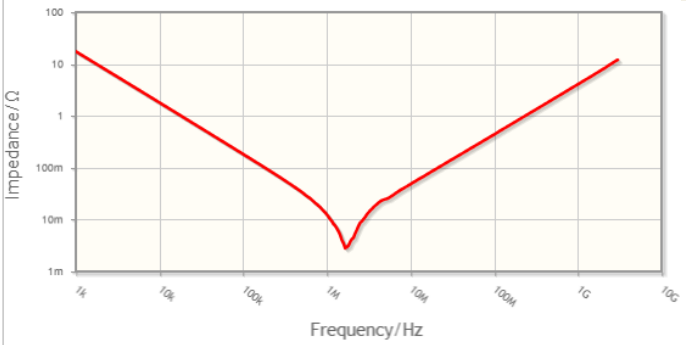
Other	
Operating Temp. Range	-55 to 150°C
Soldering Method	Wave (Flow) Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

! Images are for reference only and show exemplary products.
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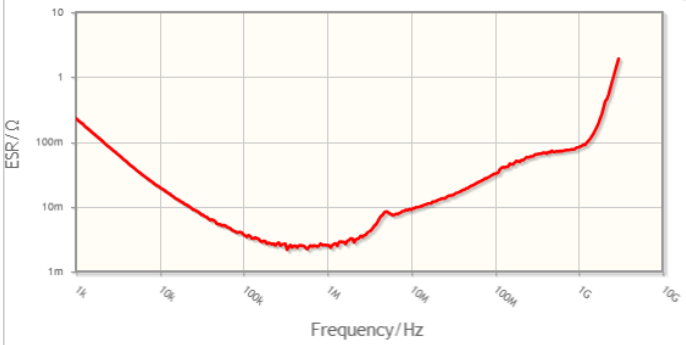
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

Impedance



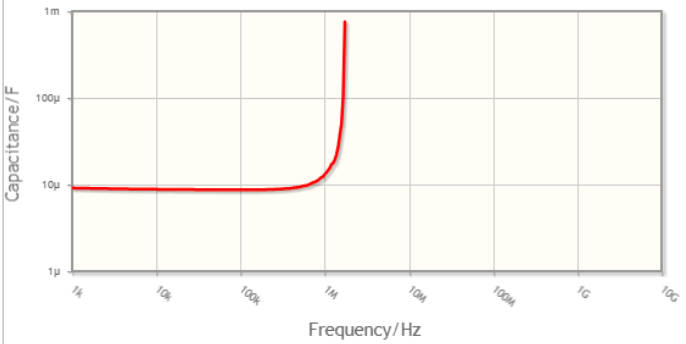
CGA4J1X8L0J106K125AC

ESR



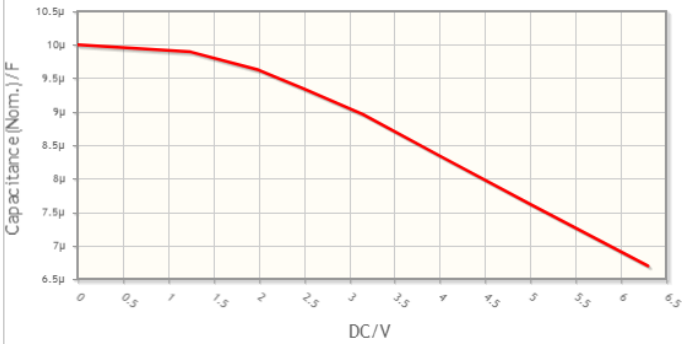
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Capacitance



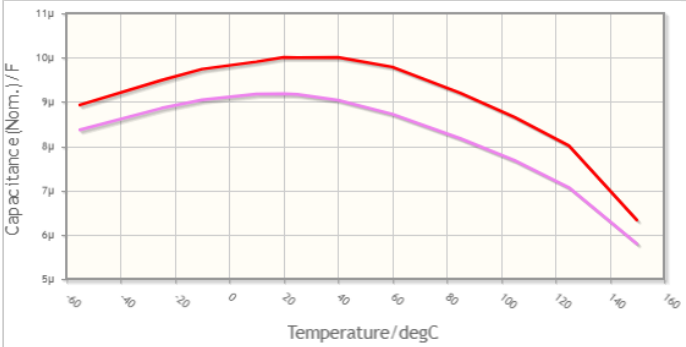
CGA4J1X8L0J106K125AC

DC Bias Characteristic



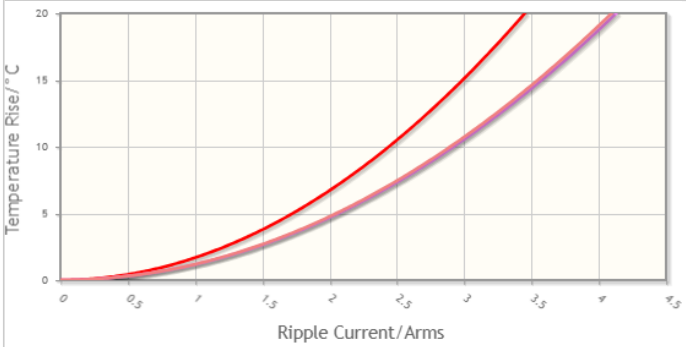
CGA4J1X8L0J106K125AC

Temperature Characteristic



CGA4J1X8L0J106K125AC(No Bias) CGA4J1X8L0J106K125AC(DC Bias = 3.15V)

Ripple Temperature Rising



CGA4J1X8L0J106K125AC(100kHz) CGA4J1X8L0J106K125AC(500kHz) CGA4J1X8L0J106K125AC(1MHz)

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Associated Images

Land Pattern (Terminal Connection)



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